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16-bit transceiver with direction pin; 3.6 V tolerant; 3-stateRev. 3 — 31 January 2013Product data s

Product data sheet

1. **General description**

The 74AVC16245 is a 16-bit transceiver featuring non-inverting 3-state bus compatible outputs in both send and receive directions. The device features two output enable inputs (nOE) for easy cascading and two send/receive inputs (nDIR) for direction control. Inputs nOE control the outputs so that the buses are effectively isolated. This device can be used as two 8-bit transceivers or one 16-bit transceiver.

The 74AVC16245 is designed to have an extremely fast propagation delay and a minimum amount of power consumption.

To ensure the high-impedance output state during power-up or power-down, tie pins nOE to V_{CC} through a pull-up resistor (Live Insertion).

A Dynamic Controlled Output (DCO) circuitry is implemented to support termination line drive during transient (see Figure 4 and Figure 5)

Features and benefits 2.

- Wide supply voltage range from 1.2 V to 3.6 V
- Complies with JEDEC standards:
 - JESD8-7 (1.2 V to 1.95 V)
 - JESD8-5 (1.8 V to 2.7 V)
 - JESD8-1A (2.7 V to 3.6 V)
- CMOS low power consumption
- Input/output tolerant up to 3.6 V
- Dynamic Controlled Output (DCO) circuit dynamically changes output impedance, resulting in noise reduction without speed degradation
- Low inductance multiple VCC and GND pins to minimize noise and ground bounce
- Supports Live Insertion

Ordering information 3.

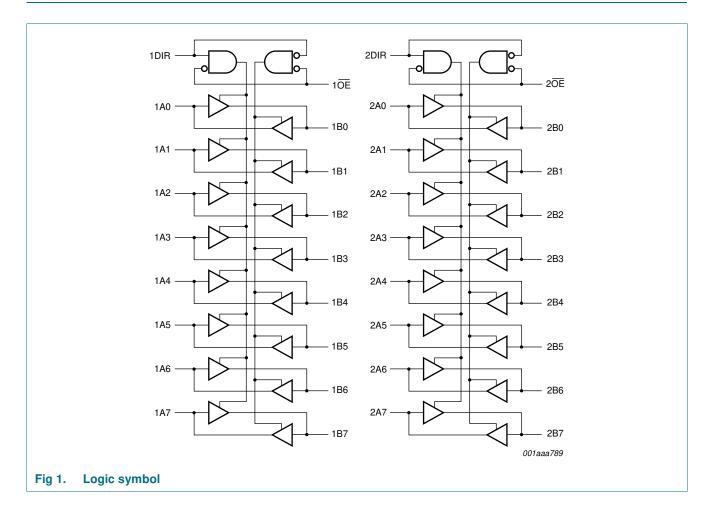
Table 1. **Ordering information**

Type number	Package			
	Temperature range	Name	Description	Version
74AVC16245DGG	-40 °C to +85 °C	TSSOP48	plastic thin shrink small outline package; 48 leads; body width 6.1 mm	SOT362-1



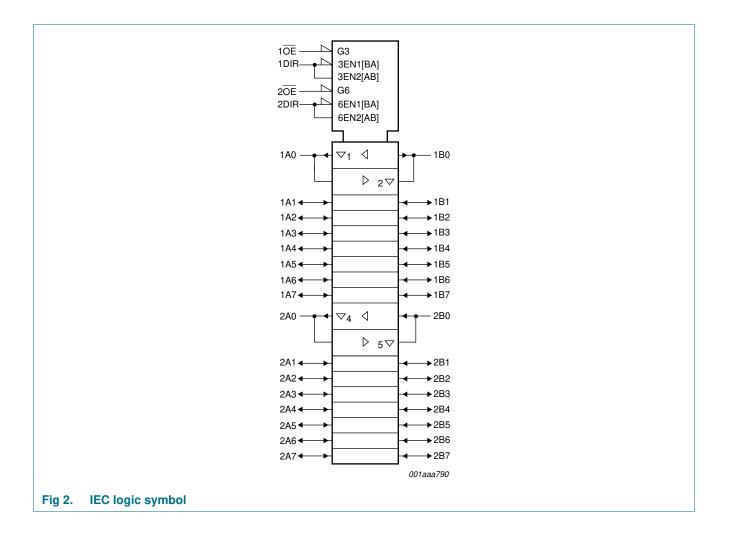
16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

Functional diagram 4.



74AVC16245

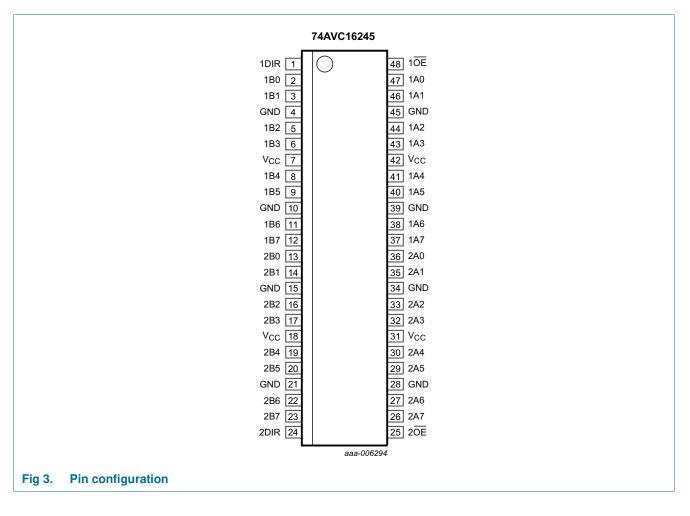
16-bit transceiver with direction pin; 3.6 V tolerant; 3-state



16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

5. Pinning information

5.1 Pinning



16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

5.2 Pin description

Table 2.Pin	description	
Symbol	Pin	Description
1DIR, 2DIR	1, 24	direction control input
1B0 to 1B7	2, 3, 5, 6, 8, 9, 11, 12	data input/output
2B0 to 2B7	13, 14, 16, 17, 19, 20, 22, 23	data input/output
GND	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)
V _{CC}	7, 18, 31, 42	supply voltage
1 <u>0E</u> , 2 <u>0E</u>	48, 25	output enable input (active LOW)
1A0 to 1A7	47, 46, 44, 43, 41, 40, 38, 37	data input/output
2A0 to 2A7	36, 35, 33, 32, 30, 29, 27, 26	data input/output

6. Functional description

Table 3.	Function table ^[1]			
Inputs		Outputs		
nOE	nDIR	nAn	nBn	
L	L	A = B	inputs	
L	Н	inputs	B = A	
Н	Х	Z	Z	

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	output HIGH or LOW	<u>[1]</u> –0.5	$V_{CC} + 0.5$	V
		output 3-state	<u>[1]</u> –0.5	+4.6	V
lo	output current	$V_{O} = 0 V \text{ to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C	[2] _	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] Above 60 °C, the value of P_{tot} derates linearly with 5.5 mW/K.

74AVC16245 Product data sheet

16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

8. Recommended operating conditions

Table 5.	Recommended operating	l conditions				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage	according to JEDEC Low Voltage Standards	1.4	-	1.6	V
			1.65	-	1.95	V
			2.3	-	2.7	V
			3.0	-	3.6	V
		for low-voltage applications	1.2	-	3.6	V
VI	input voltage		0	-	3.6	V
Vo	output voltage	output HIGH or LOW	0	-	V_{CC}	V
		output 3-state	0	-	3.6	V
T _{amb}	ambient temperature	in free air	-40	-	+85	°C
$\Delta t / \Delta V$	input transition rise and fall	V _{CC} = 1.4 V to 1.6 V	0	-	40	ns/V
	rate	V _{CC} = 1.65 V to 1.95 V	0	-	30	ns/V
		$V_{CC} = 2.3 \text{ V to } 3.0 \text{ V}$	0	-	20	ns/V
		V _{CC} = 3.0 V to 3.6 V	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

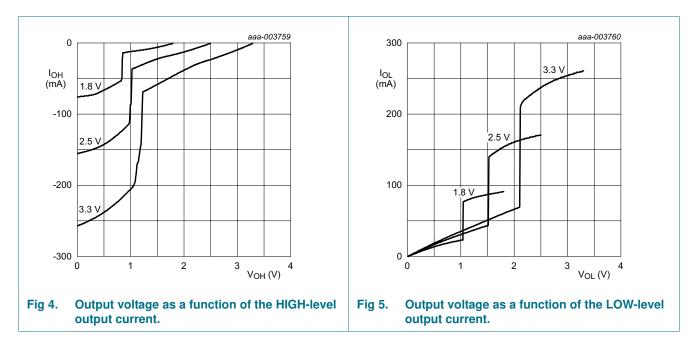
Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
T _{amb} = -	40 °C to +85 °C					
V _{IH}	HIGH-level input voltage	V _{CC} = 1.2 V	V _{CC}	-	-	V
		$V_{CC} = 1.4 V$ to 1.6 V	$0.65 \times V_{CC}$	0.9	-	V
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V	$0.65 \times V_{CC}$	0.9	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	1.2	-	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	1.5	-	V
V _{IL} LOW-level input voltage		V _{CC} = 1.2 V	-	-	GND	V
		$V_{CC} = 1.4 V$ to 1.6 V	-	0.9	$0.35 \times V_{CC}$	V
		V _{CC} = 1.65 V to 1.95 V	-	0.9	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	1.2	0.7	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	1.5	0.8	V
V _{OH}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		I_{O} = –100 $\mu A;$ V_{CC} = 1.65 V to 3.6 V	$V_{CC}-0.20$	V _{CC}	-	V
		$I_{O} = -3 \text{ mA}; V_{CC} = 1.4 \text{ V}$	$V_{CC}-0.35$	$V_{CC}-0.21$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	$V_{CC}-0.45$	$V_{CC}-0.25$	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	$V_{CC}-0.55$	$V_{CC}-0.37$	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	$V_{CC}-0.70$	$V_{CC}-0.47$	-	V

16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

At recom	mended operating conditions	. Voltages are referenced to GND (ground	= 0 V).			
Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
V _{OL}	LOW-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		I_O = 100 $\mu A;V_{CC}$ = 1.65 V to 3.6 V	-	GND	0.20	V
		$I_{O} = 3 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	0.22	0.35	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	0.24	0.45	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	0.38	0.55	V
		$I_{O} = 12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	0.53	0.70	V
I _I	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 1.4$ V to 3.6 V	-	0.1	2.5	μ A
I _{OFF}	power-off leakage current	$V_{\rm I}~or~V_{\rm O}$ = 3.6 V; $V_{\rm CC}$ = 0.0 V	-	±0.1	±10	μ A
I _{OZ}	OFF-state output current	$V_I = V_{IH} \text{ or } V_{IL}; V_O = V_{CC} \text{ or } GND$				
		$V_{CC} = 1.4 \text{ V} \text{ to } 2.7 \text{ V}$	-	0.1	5	μ A
		$V_{CC} = 3.0 V \text{ to } 3.6 V$	-	0.1	10	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A				
		V_{CC} = 1.4 V to 2.7 V	-	0.1	20	μA
		V_{CC} = 3.0 V to 3.6 V	-	0.2	40	μA
CI	input capacitance		-	5.0	-	pF

Table 6. Static characteristics ... continued

[1] All typical values are measured at $T_{amb} = 25$ °C.



9.1 Graphs

16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		-40) °C to +85	S°C	Unit
				Min	Typ ^[2]	Max	
t _{pd}	propagation delay	nAn to nBn; nBn to nAn; see Figure 6	[1]				
		$V_{CC} = 1.2 V$		-	2.8	-	ns
		$V_{CC} = 1.4 V$ to 1.6 V		-	1.8	-	ns
		V _{CC} = 1.65 V to 1.95 V		0.7	1.8	3.0	ns
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		0.6	1.3	1.9	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		0.5	1.1	1.7	ns
t _{en}	enable time	nOE to nAn, nBn; see Figure 7	[1]				
	$V_{CC} = 1.2 V$		-	5.9	-	ns	
		$V_{CC} = 1.4 \text{ V}$ to 1.6 V		-	3.9	-	ns
		V _{CC} = 1.65 V to 1.95 V		1.4	3.3	6.5	ns
		$V_{CC} = 2.3 \text{ V}$ to 2.7 V		1.0	2.4	4.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		0.7	2.0	3.7	ns
t _{dis}	disable time	nOE to nAn, nBn; see Figure 7	[1]				
		V _{CC} = 1.2 V		-	6.9	-	ns
		$V_{CC} = 1.4 V$ to 1.6 V		-	4.8	-	ns
		V _{CC} = 1.65 V to 1.95 V		2.2	3.7	6.0	ns
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		1.1	2.0	4.2	ns
		V _{CC} = 3.0 V to 3.6 V		1.2	2.2	3.7	ns
C _{PD}	power dissipation	per input; $V_I = GND$ to V_{CC}	[3]				
	capacitance	outputs enabled		-	42	-	pF
		outputs disabled		-	2	-	pF

[1] t_{pd} is the same as t_{PLH} and t_{PHL} .

 t_{en} is the same as t_{PZL} and t_{PZH} .

 t_{dis} is the same as t_{PLZ} and t_{PHZ} .

[2] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.5 V, 1.8 V, 2.5 V and 3.3 V respectively.

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

 C_L = output load capacitance in pF

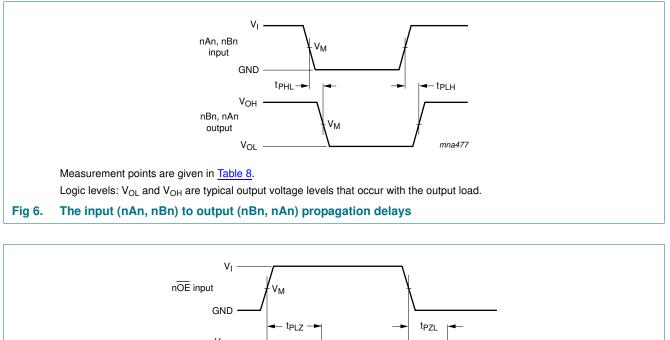
V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs.

16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

11. Waveforms



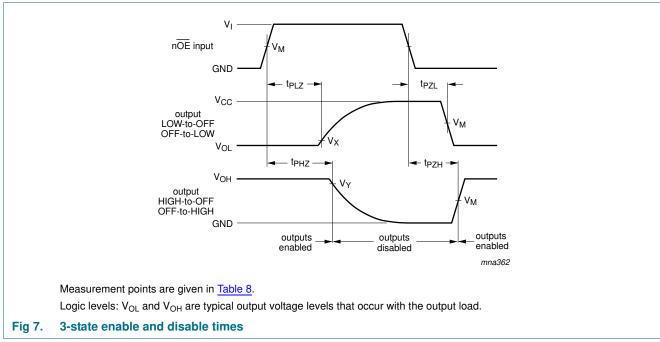


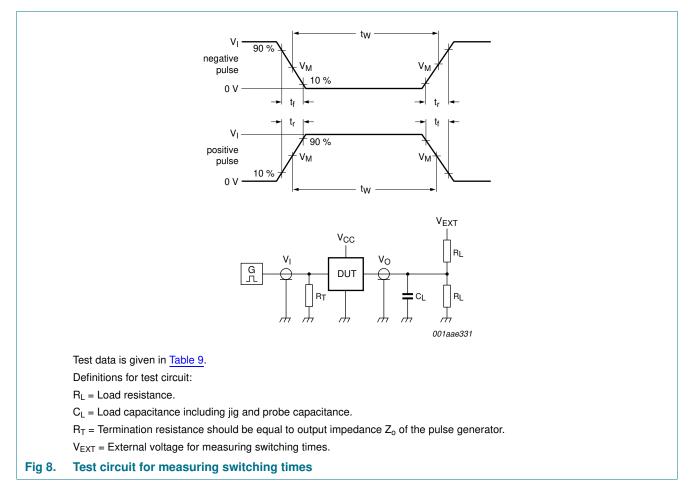
Table 8. **Measurement points**

Supply voltage	V _M	Input	Input				
V _{CC}		VI	$t_r = t_f$	V _X	V _Y		
1.2 V	$0.5\times V_{CC}$	V _{CC}	\leq 2 ns	V _{OL} + 0.15 V	V _{OH} – 0.15 V		
1.4 V to 1.6 V	$0.5\times V_{CC}$	V _{CC}	\leq 2 ns	V _{OL} + 0.15 V	V _{OH} – 0.15 V		
1.65 V to 1.95 V	$0.5\times V_{CC}$	V _{CC}	\leq 2 ns	V _{OL} + 0.15 V	V _{OH} – 0.15 V		
2.3 V to 2.7 V	$0.5\times V_{CC}$	V _{CC}	\leq 2 ns	V _{OL} + 0.15 V	V _{OH} – 0.15 V		
3.0 V to 3.6 V	$0.5\times V_{CC}$	V _{CC}	\leq 2 ns	V _{OL} + 0.3 V	$V_{OH} - 0.3 \ V$		

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Supply voltage	Input		Load	Load		V _{EXT}		
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	\leq 2 ns	15 pF	2 kΩ	open	$2 \times V_{CC}$	GND	
1.4 V to 1.6 V	V _{CC}	\leq 2 ns	15 pF	2 kΩ	open	$2\times V_{CC}$	GND	
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	

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12. Package outline

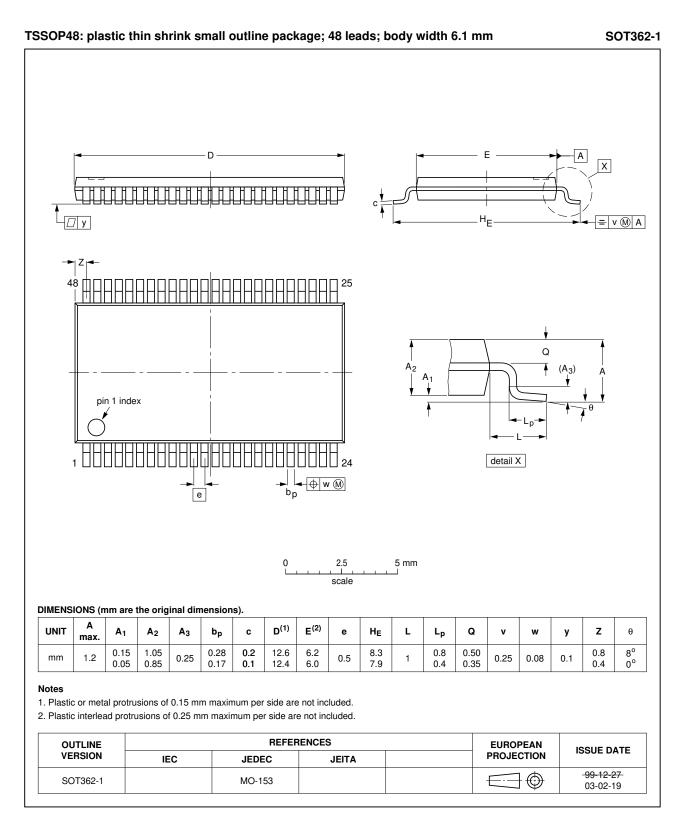


Fig 9. Package outline SOT362-1 (TSSOP48)

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13. Abbreviations

Table 10. Abbrevenue	viations
Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
TTL	Transistor-Transistor Logic

14. Revision history

Table 11.Revision history

Document ID	Release date	Data sheet status	Change notice	Order number	Supersedes
74AVC16245 v.3	20130131	Product data sheet	-	-	74AVC16245 v.2
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. 				
	 Legal text 	s have been adapted to th	ne new company r	ame where appr	opriate.
74AVC16245 v.2	19991115	Product specification	-	-	74AVC16245 v.1
74AVC16245 v.1	19981211	Product specification	-	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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74AVC16245

16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

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